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APPLICATION NO.	FILING DA	ATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/721,062	11/24/2003		Patrick W. Tandy	MCT.0046C1US (99-0200.02/	3265	
7590 06/14/2005				EXAM	EXAMINER	
Trop, Pruner &	k Hu, P.C.	RICHARDS, N DREW				
Suite 100						
8554 Katy Free	way		ART UNIT	PAPER NUMBER		
Houston, TX 77024				2815		
			DATE MAILED: 06/14/2005			

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)				
	10/721,062	TANDY, PATRICK W.				
Office Action Summary	Examiner	Art Unit				
	N. Drew Richards	2815				
The MAILING DATE of this communication apperiod for Reply						
A SHORTENED STATUTORY PERIOD FOR REP THE MAILING DATE OF THIS COMMUNICATION  - Extensions of time may be available under the provisions of 37 CFR 1 after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a re  - If NO period for reply is specified above, the maximum statutory period  - Failure to reply within the set or extended period for reply will, by statu Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	136(a). In no event, however, may a reply be to ply within the statutory minimum of thirty (30) dad will apply and will expire SIX (6) MONTHS from the cause the application to become ABANDON	imely filed  ys will be considered timely.  n the mailing date of this communication.  ED (35 U.S.C. § 133).				
Status						
1) Responsive to communication(s) filed on 28	February 2005.					
3) Since this application is in condition for allow closed in accordance with the practice under						
Disposition of Claims		•				
4)⊠ Claim(s) <u>37-39,42,47 and 50-63</u> is/are pending in the application.						
4a) Of the above claim(s) is/are withdr	awn from consideration.					
5) Claim(s) <u>37-39,42 and 50-63</u> is/are allowed.						
6)⊠ Claim(s) <u>43-47</u> is/are rejected.						
7) Claim(s) is/are objected to.	for election requirement					
8) Claim(s) are subject to restriction and	or election requirement.					
Application Papers						
9) The specification is objected to by the Examir						
10) The drawing(s) filed on 24 November 2003 is.		•				
Applicant may not request that any objection to th Replacement drawing sheet(s) including the corre	• • • • • • • • • • • • • • • • • • • •	•				
11) The oath or declaration is objected to by the E	,					
Priority under 35 U.S.C. § 119						
12) Acknowledgment is made of a claim for foreig		a)-(d) or (f).				
1. Certified copies of the priority documer						
<ul><li>2. Certified copies of the priority documer</li><li>3. Copies of the certified copies of the priority</li></ul>	' '					
application from the International Bure	*	reu III (IIIS National Stage				
* See the attached detailed Office action for a lis	, , , , , , , , , , , , , , , , , , , ,	ved.				
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		•				
Attachment(s)	»□	(DTO 440)				
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948)	4) 🔲 Interview Summar Paper No(s)/Mail [					
3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/06 Paper No(s)/Mail Date 249995, 3/3/5/		Patent Application (PTO-152)				

#### **DETAILED ACTION**

## Claim Rejections - 35 USC § 112

- 1. The following is a quotation of the second paragraph of 35 U.S.C. 112:
  - The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.
- 2. Claim 43 is rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.

It is indefinite as to whether claim 43 line 2 is claiming a further support structure or whether this is claiming the same support structure recited in claim 37. It is further indefinite as to whether claim 43 is further limiting the support structure itself by saying that it is now planar or whether it is limiting the placement of the first and second bond pads by reciting that they coexist on a (single) plane.

## Claim Rejections - 35 USC § 102

3. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (a) the invention was known or used by others in this country, or patented or described in a printed publication in this or a foreign country, before the invention thereof by the applicant for a patent.
- 4. Claims 44 and 46 are rejected under 35 U.S.C. 102(a) as being anticipated by Haji et al. (U.S. Patent No. 5,909,633).

With regard to claim 44, Haji discloses in figure 17 and column 1, lines 13-20 and lines 50-60 an intermediate structure for an integrated circuit device. Haji discloses in

figure 17 and column 1, lines 13-20 a first bond pad (6/4/2) comprising a gold coated (6) metal (4/2), the gold coating having a thickness of between about 0.1 and 0.5 microns. It should be noted that 0.2 to 1.0 microns reads on the limitation of about 0.1 – 0.5 microns. Haji discloses in figure 17 and column 1 lines 13-20 a second bond pad (5/3) the second bond pad comprising a nickel coated (5) metal (3). Haji disclose in column 1 lines 55-60 the second bond pad being masked during the gold plating such that only the first bond pad is coated with gold, this anticipates the claims second bond pad being masked and without a gold coating.

With regard to claim 46, Haji discloses in column 1 lines 13-200 wherein the second bond pad comprises a nickel coated (5) copper (3).

# Claim Rejections - 35 USC § 103

- 5. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 6. Claim 47 is rejected under 35 U.S.C. 103(a) as being unpatentable over Haji.

Haji teach in figure 17, the first and second bond pads being formed on different planar surfaces of the same support substrate. However, Haji figure 17 does not teach the first and second bond pads being on the same planar surface. Nonetheless, this is taught by Haji figure 16(a), which shows the first 87 and second 88 bond pads on the same planar surface. It would have been obvious to one of ordinary skill in the art to

Application/Control Number: 10/721,062 Page 4

Art Unit: 2815

form the bond pads on the same planar surface to allow for bonding of multiple chips onto the same surface of a carrier board and to allow bonding by both solder bonding and wire bonding to allow great flexibility in the types of chips that can be integrated onto a single carrier board.

7. Claims 45 is rejected under 35 U.S.C. 103(a) as being unpatentable over Haji as applied to claims 44 and 46 above, respectively, above, and further in view of Thomas et al. (USPAT 5625734, Thomas).

With regard to claim 45, Haji<sup>1</sup> discloses in figure 4, figure 9a and column 5, lines 11 – 12 wherein the first bond pad comprises a nickel coated copper. Haji<sup>1</sup> is silent to the metal of the first bond pad being aluminum. Thomas discloses in column 3, lines 28 – 37 a first bond pad comprising aluminum. It would have been obvious to one of ordinary skill in the art at the time of the present invention to use the bond pad comprising aluminum of Thomas for the first bond pad of Haji<sup>1</sup> in order to use a material that is equivalent for the purpose of a bond pad.

## Allowable Subject Matter

8. Claims 37-39, 42, 50-63 are allowed.

# Response to Arguments

9. Applicant's arguments with respect to claim 44 has been considered but are moot in view of the new ground(s) of rejection.

#### Conclusion

10. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to N. Drew Richards whose telephone number is (571) 272-1736. The examiner can normally be reached on Monday-Friday 9:00-5:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Tom Thomas can be reached on (571) 272-1664. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Application/Control Number: 10/721,062

Art Unit: 2815

Page 6

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

NDR

TOM THOMAS
SUPERVISORY PATENT EXAMINER